# Imagine the invisible



# Xeva-2.5-320 TE4

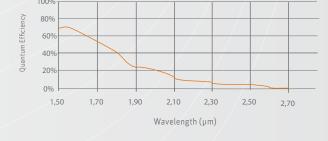
Versatile SWIR T2SL camera with response up to 2.5 µm

# Superior performance for reliable research

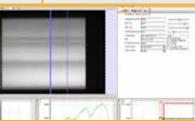
The Xeva-2.5-320 is a compact digital camera operating a T2SL detector array for imaging in the 1.0 to 2.5  $\mu m$  wavelength range. The camera features a resolution of 320 x 256 pixels with a 30  $\mu m$  pixel pitch. It outputs 14-bit data and comes in a 100 Hz or 350 Hz version.

The camera interfaces to a PC via standard USB 2.0 and CameraLink. Each camera is delivered with a Graphical User Interface (GUI) Xeneth, which offers direct access to various camera settings such as exposure time and operating temperature.

Through its advanced thermomechanical design, the Xeva-2.5-320 achieves excellent performance levels using a TE4-cooled device operating down to 203K.



#### Designed for use in







Art inspection

#### **Applications**

- R&D (SWIR range)
- · Semiconductor inspection
- Hyperspectral SWIR imaging
- Art inspection (seeing through paint)
- Laser beam profiling (1.0 2.5 μm)

#### **Benefits & Features**

- Spectrometer compatible
- · CameraLink for high speed imaging
- Scientific image recording and analysis
- High speed SWIR imaging up to 2.5 μm
- Windowing mode for even higher frame rates
- Flexible programming in an open architecture

Smallest TE4-cooled camera for low dark current

Two gain modes for High Sensitivity (HS) or High Dynamic Range (HDR)

# Complete camera and software package to simplify your research



### **▶** Specifications

Camera specifications	100 Hz	350 Hz	
Lens (included)			
Focal length	Visible lens, 16 mm f/1.4		
Optical interface	C-Mount		
Imaging performance			
Maximum frame rate	100 Hz	344 Hz full frame; > 10 kHz at 128x8 window	
Window of Interest (WoI)	No	Minimum 128 x 8 pixels	
Integration type	Snapshot		
Noise	High gain: 150 electrons; HDR**: 1000 electrons	5;	
Gain	High gain: 10 electrons/ADU; HDR**: 210 electrons/ADU		
A to D conversion resolution	14 bit per pixel		
Interfaces			
Camera control	USB 2.0		
Image acquisition	CameraLink or USB 2.0	CameraLink	
Trigger	TTL Levels		
Graphical User Interface (GUI)	Xeneth Advanced		
Power consumption	7W without cooling; 84 W @ maximum cooling 24 V		
Input voltage			
Physical characteristics			
Camera cooling	Forced convection cooling Approximately 2 minutes		
Cool-down time			
Ambient operating temperature	0 to 40 °C		
Dimensions	87 W x 115 H x 109 L mm <sup>3</sup>		
Weight camera head	App. 1.8 kg (without lens)		

*	Тур	ical	value

<sup>&</sup>quot; High Dynamic Range mode

Array specifications	Xeva-2.5-320
Array type	T2SL
Spectral band	1.0 μm to 2.5 μm
Resolution	320 x 256
Pixel pitch	30 μm
Array dimensions	W: 9.6 mm H: 7.68 mm D: 12.29 mm or 0.48 in
ROIC noise	High gain: 70 electrons; Low gain: 700 electrons
Integration capacitor	High gain: 10 fF; Low gain: 210 fF
Full well	High gain: 0.17 x 10 <sup>6</sup> electrons Low gain: 3.5 x 10 <sup>6</sup> electrons
Array cooling	TEC 4 stages (typical sensor temperature 203 K or -70 °C)
Pixel operability	> 99 %
Dark current*	150 x 10 <sup>6</sup> e-/s/pixel

## **Product selector guide** ■

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Part number	Date interface	Cooling	Frame rate	ADC
XEN-000617	CL/USB	TE4	100 Hz	14 bit
XEN-000618	CL		344 Hz	14 010

